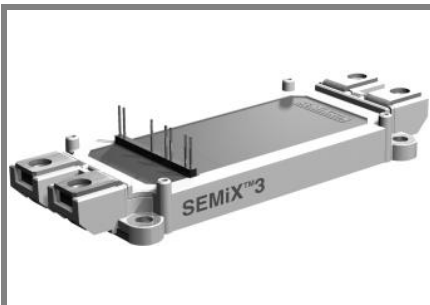


SEMiX 353GB176HD



SEMiX[®] 3

Trench IGBT Modules

SEMiX 353GB176HD

Preliminary Data

Features

- Homogeneous Si
- Trench = Trenchgate technology
- $V_{CE(sat)}$ with positive temperature coefficient
- High short circuit capability

Typical Applications

- AC inverter drives
- UPS
- Electronic welders

Remarks

- short circuit capability is tested @ $V_{CC}=1000V$ (all other static parameters are tested @ $V_{CC}=1200V$)
- Not for new design

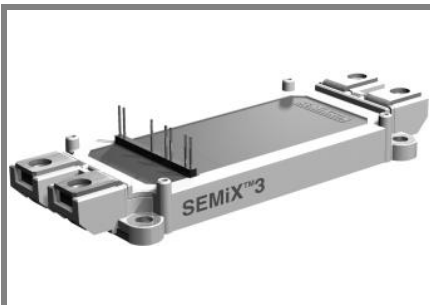


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Absolute Maximum Ratings		$T_c = 25^\circ C$, unless otherwise specified			
Symbol	Conditions	Values		Units	
IGBT					
V_{CES}	$T_j = 25^\circ C$	1700		V	
I_C	$T_j = 150^\circ C$	$T_{case} = 25^\circ C$	350		A
		$T_{case} = 80^\circ C$	250		A
I_{CRM}	$I_{CRM} = 2 \times I_{Cnom}$	450		A	
V_{GES}		± 20		V	
t_{psc}	$V_{CC} = 1200 V$; $V_{GE} \leq 20 V$; $T_j = 125^\circ C$ $V_{CES} < 1700 V$	10		μs	
Inverse Diode					
I_F	$T_j = 150^\circ C$	$T_c = 25^\circ C$	425		A
		$T_c = 80^\circ C$	285		A
I_{FRM}	$I_{FRM} = 2 \times I_{Fnom}$	450		A	
I_{FSM}	$t_p = 10 ms$; sin.	$T_j = 25^\circ C$	1800		A
Module					
$I_{t(RMS)}$		600		A	
T_{vj}		- 40 ... + 150		$^\circ C$	
T_{stg}		- 40 ... + 125		$^\circ C$	
V_{isol}	AC, 1 min.	4000		V	

Characteristics		$T_c = 25^\circ C$, unless otherwise specified			
Symbol	Conditions	min.	typ.	max.	Units
IGBT					
$V_{GE(th)}$	$V_{GE} = V_{CE}$, $I_C = 9 mA$	5,2	5,8	6,4	V
I_{CES}	$V_{GE} = 0 V$, $V_{CE} = V_{CES}$			0,45	mA
V_{CE0}		$T_j = 25^\circ C$	1		V
		$T_j = 125^\circ C$	0,9		V
r_{CE}	$V_{GE} = 15 V$	$T_j = 25^\circ C$	4,4		m Ω
		$T_j = 125^\circ C$	6,9		m Ω
$V_{CE(sat)}$	$I_{Cnom} = 225 A$, $V_{GE} = 15 V$	$T_j = 25^\circ C_{chiplev.}$	2		V
		$T_j = 125^\circ C_{chiplev.}$	2,45		V
C_{ies}	$V_{CE} = 25$, $V_{GE} = 0 V$			19,9	nF
C_{oes}				0,83	nF
C_{res}				0,66	nF
Q_G	$V_{GE} = -8 V \dots +15 V$			2100	nC
$t_{d(on)}$	$R_{Gon} = 5,6 \Omega$	$V_{CC} = 1200V$ $I_{Cnom} = 225A$	250		ns
t_r			75		ns
E_{on}	$R_{Goff} = 5,6 \Omega$	$T_j = 125^\circ C$	155		mJ
$t_{d(off)}$			930		ns
t_f			180		ns
E_{off}			85		mJ
$R_{th(j-c)}$	per IGBT			0,086	K/W

SEMiX 353GB176HD



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Trench IGBT Modules

SEMiX 353GB176HD

Preliminary Data

Features

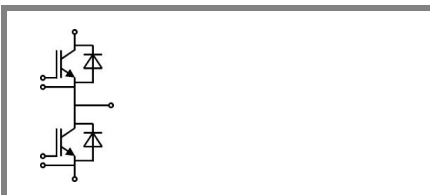
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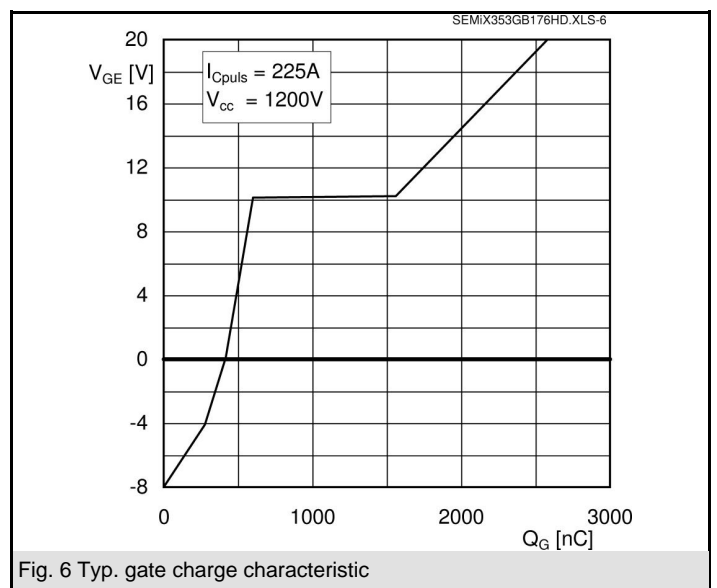
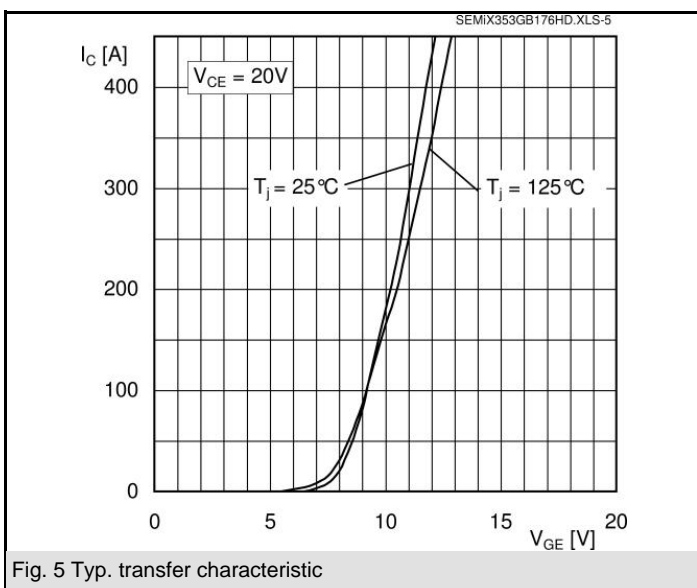
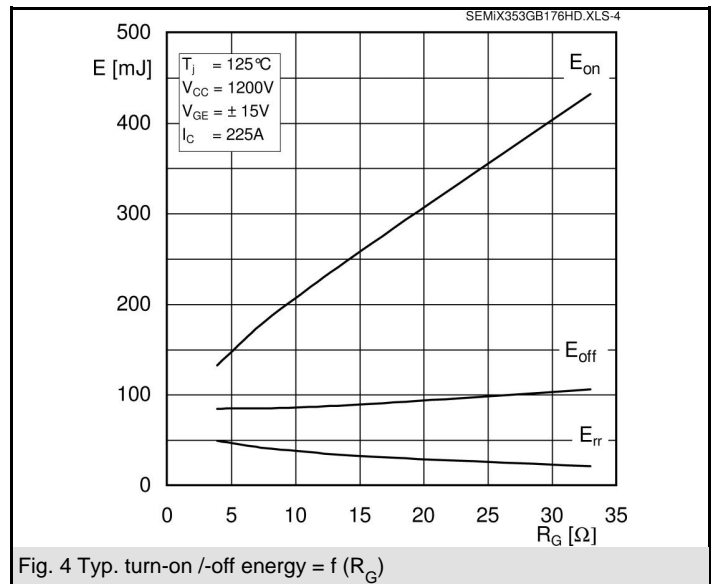
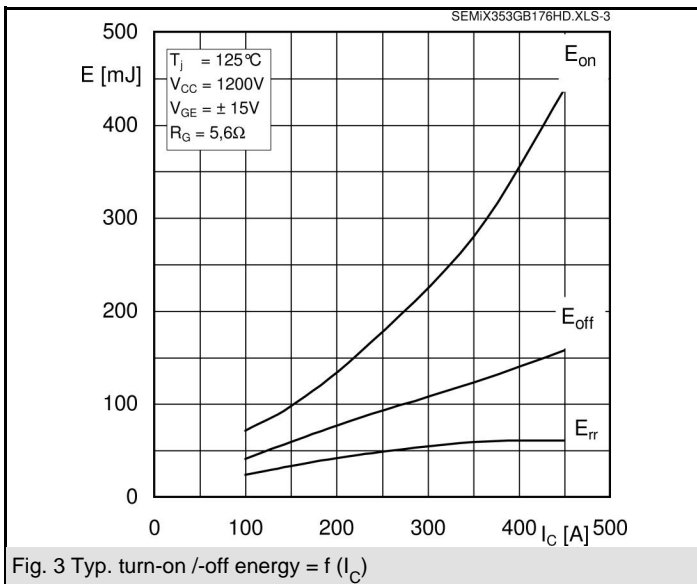
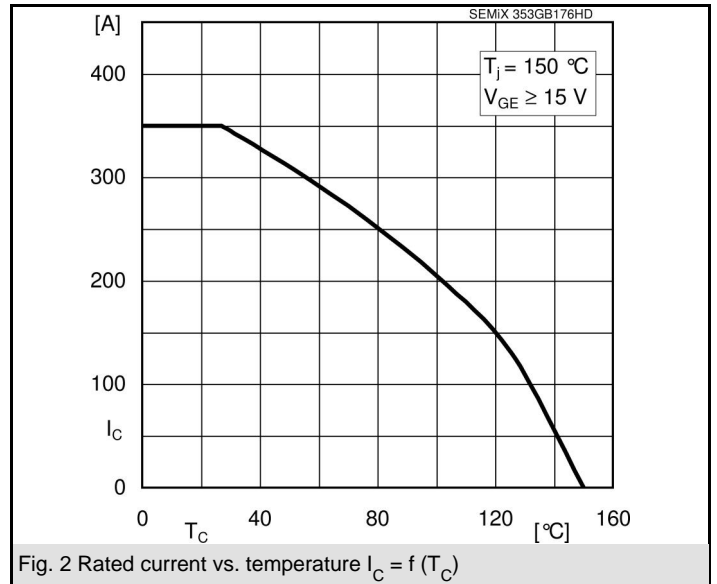
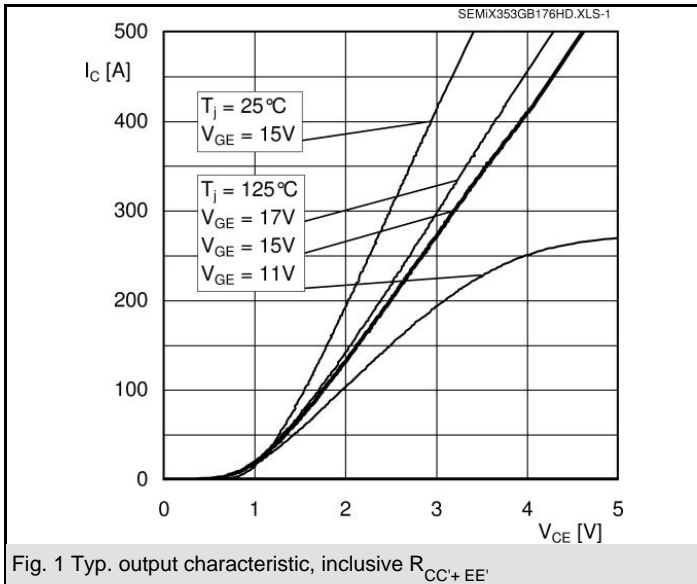


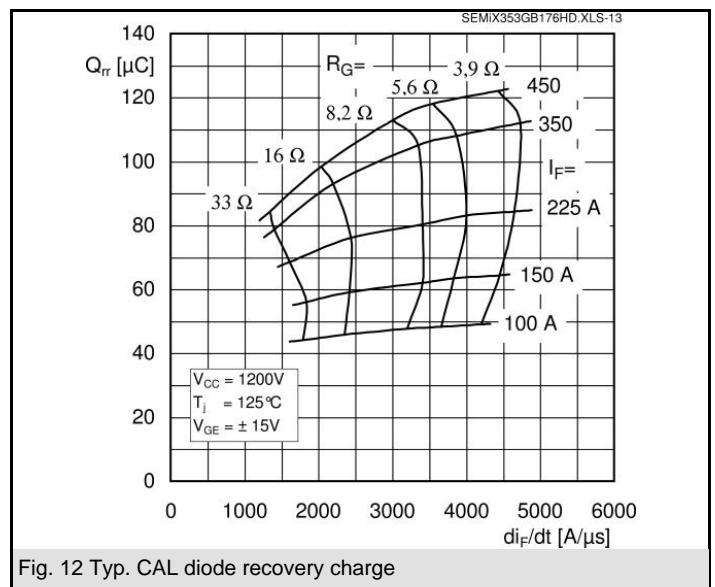
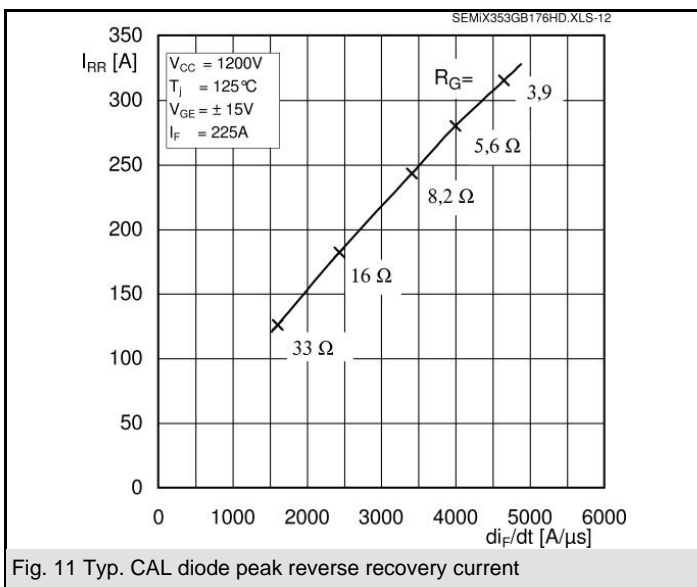
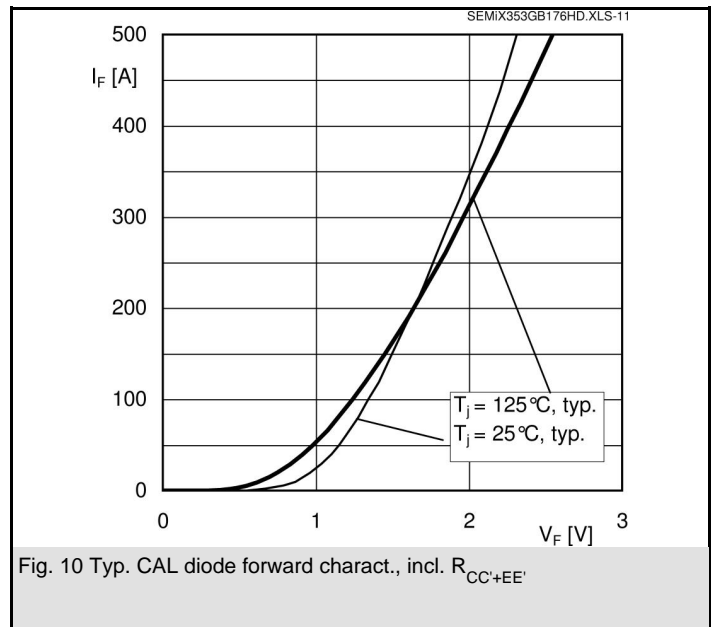
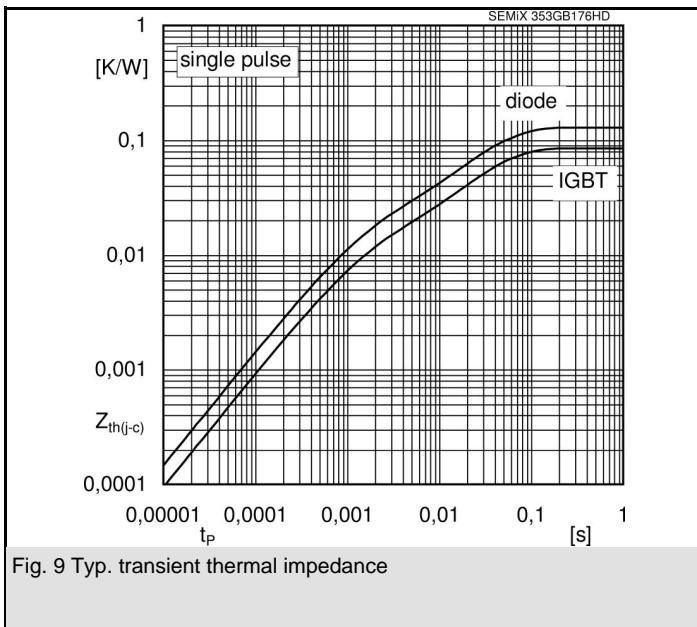
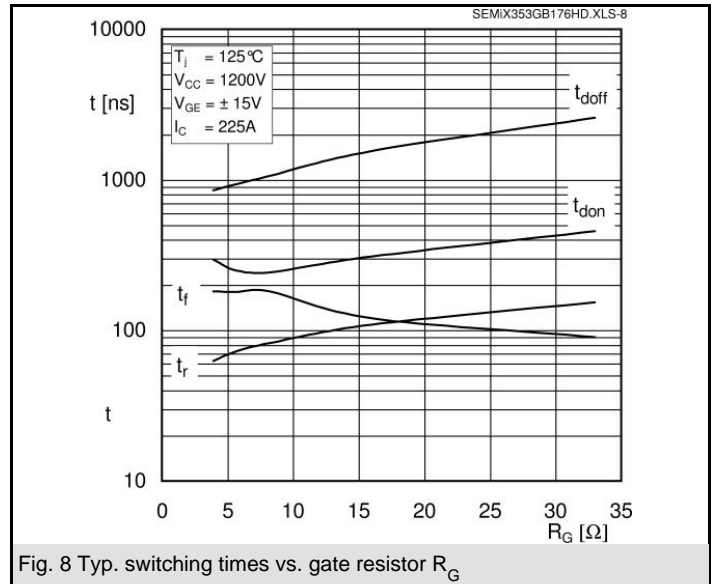
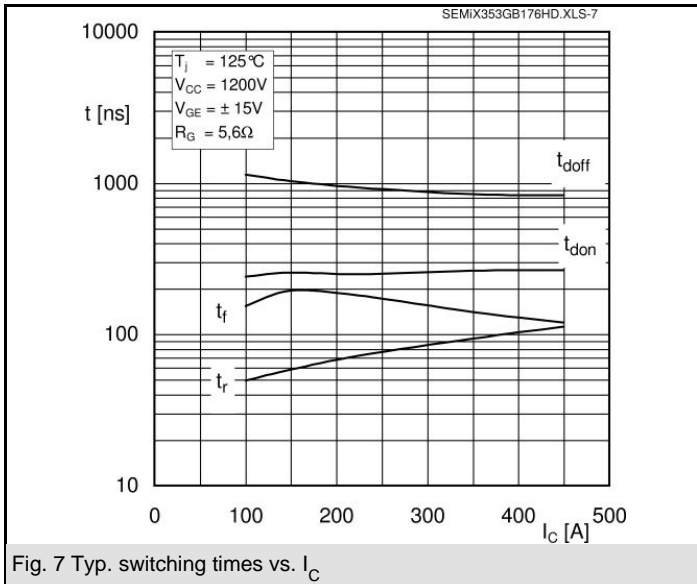
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Characteristics					
Symbol	Conditions	min.	typ.	max.	Units
Inverse Diode					
$V_F = V_{EC}$	$I_{Fnom} = 225 A; V_{GE} = 0 V$				
	$T_j = 25 ^\circ C_{chiplev.}$		1,55	1,75	V
	$T_j = 125 ^\circ C_{chiplev.}$		1,5	1,7	V
V_{F0}					
	$T_j = 25 ^\circ C$		1,1	1,3	V
	$T_j = 125 ^\circ C$		0,9	1,1	V
r_F					
	$T_j = 25 ^\circ C$		2		mΩ
	$T_j = 125 ^\circ C$		2,7		mΩ
I_{RRM}	$I_{Fnom} = 225 A$		280		A
Q_{rr}	$di/dt = 4000 A/\mu s$		83		μC
E_{rr}	$V_{GE} = -15 V; V_{CC} = 1200 V$		45		mJ
$R_{th(j-c)D}$	per diode			0,13	K/W
Module					
L_{CE}			20		nH
$R_{CC'+EE'}$	res., terminal-chip	$T_{case} = 25 ^\circ C$	0,7		mΩ
		$T_{case} = 125 ^\circ C$	1		mΩ
$R_{th(c-s)}$	per module		0,04		K/W
M_s	to heat sink M5		3	5	Nm
M_t	to terminals M6		2,5	5	Nm
w				300	g
Temperature sensor					
R_{100}	$T_c = 100^\circ C (R_{25} = 5 k\Omega)$		0,493±5%		kΩ
$B_{100/125}$	$R(T) = R_{100} \exp[B_{100/125} (1/T - 1/T_{100})]$; $T[K]; B$		3550±2%		K

This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX.

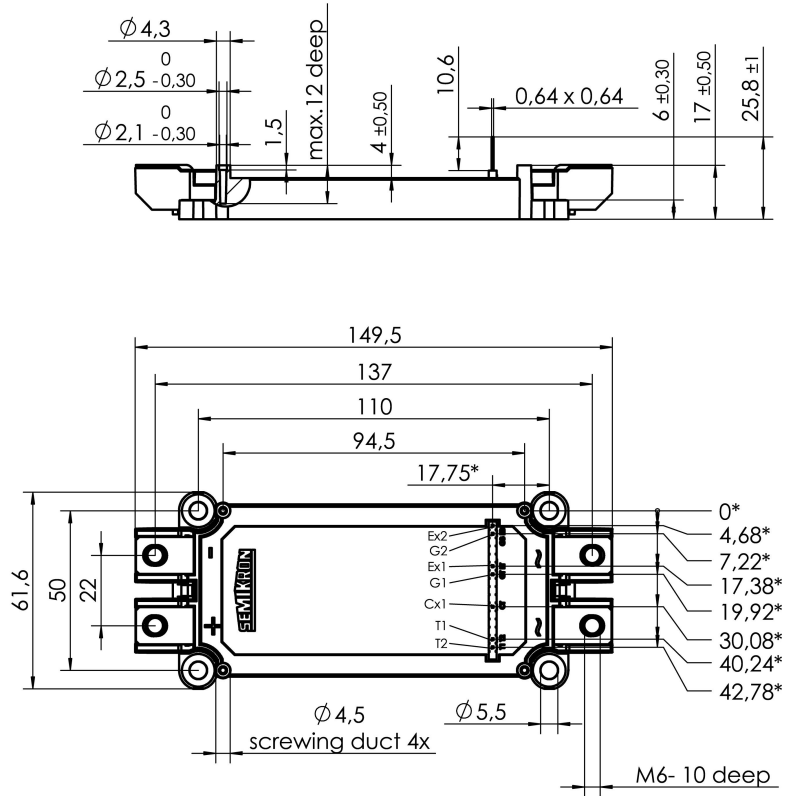
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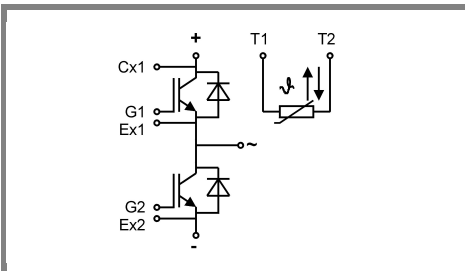
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case: SEMiX 3



* = all measures with $\pm 0,5$

Case SEMiX 3



Pinout

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